

STEVAL-IFP006V1

Quad high side smart power solid state relay evaluation board using the VNI4140K

Data Brief

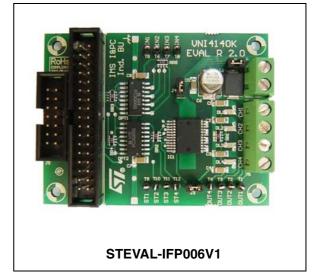
Features

- Shorted load protections
- Junction over-temperature protection
- Case over-temperature protection for thermal independence of the channels
- Thermal case shut-down non-simultaneous restart for the various channels
- Protection against loss of ground
- Current limitation
- Undervoltage shut-down
- Open drain diagnostic outputs
- 3.3 V CMOS/TTL compatible inputs
- Fast demagnetization of inductive loads
- Conforms to IEC 61131-2

Description

The purpose of this design is to demonstrate the features of the VNI4140K quad high side smart power solid state relay. The application offers robustness and complies with EMC industrial standards. It implements short-circuit/overload protection and thermal management as well, achieving best-in-class MTBF values. The reference design is suitable for use in programmable logic controllers (PLCs) as well as to drive generic loads which require up to 0.7 A of nominal current (the typical current limitation is 0.7 - 1.7 A). Thanks to the very low R_{DS(on)} (only 80 m Ω typ. @ 25 °C per channel) the device allows very low power consumption during operation and for this reason making it an ideal solution for IP65 / IP67 requirements. The device is compliant with IEC 61131-2 (Programmable Controllers International Standard).

For further information contact your local STMicroelectronics sales office.



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1 Board schematic

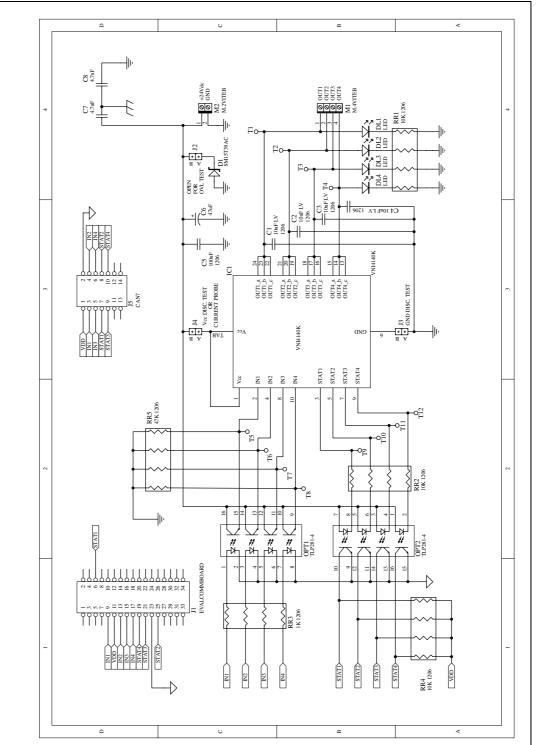


Figure 1. Schematic diagram



2 Connectors

This evaluation board uses two input header connectors, one screw drives the four-channels output connector and one screw drives the two-channel supply connector.

Both input connectors, J5 and J1, provide the same bidirectional evaluation board signalization guaranteeing the maximum compatibility with existing ST tools, such as the ST7540 FSK powerline transceiver evaluation board (see AN2451) and similar.

Figure 2. J1 connector pinout

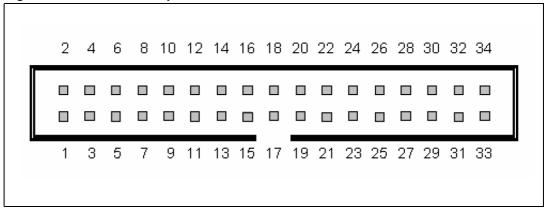
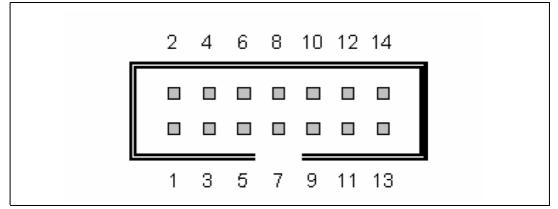


Figure 3. J5 connector pinout





J1 pin number	J5 pin number	Signal	Туре		
11	1	Vdd	5/3.3 V supply voltage		
23	2	GND	Signal ground		
9	3	IN1	Input channel 1		
13	4	IN2	Input channel 2		
15	5	IN3	Input channel 3		
17	6	IN4	Input channel 4		
6	7	STAT1	Status channel 1		
25	8	STAT2	Status channel 2		
21	9	STAT3	Status channel 3		
19	10	STAT4	Status channel 4		

 Table 1.
 Connector J1 and J5 pinout mapping



3 Bill of materials

Table 2. Evaluation board bill of material

Designator	Part	Description	
RR1	10 kΩ x 4	SMD resistor pack 1206 format	
RR2	10 kΩ x 4	SMD resistor pack 1206 format	
RR3	1 kΩx 4	SMD resistor pack 1206 format	
RR4	10 kΩ x 4	SMD resistor pack 1206 format	
RR5	47 kΩ x 4	SMD resistor pack 1206 format	
C1	10 nF LV	SMD capacitor 1206 format	
C2	10 nF LV	SMD capacitor 1206 format	
C3	10 nF LV	SMD capacitor 1206 format	
C4	10 nF LV	SMD capacitor 1206 format	
C5	100 nF	SMD capacitor 1206 format	
C6	47 μF 50 V	SMD electrolitic capacitor	
C7	4.7 nF	SMD capacitor 1206 format	
C8	4.7 nF	SMD capacitor 1206 format	
D1	SM15T39AC	Transil diode	
DL1	LED	SMD LED diode 0805 format	
DL2	LED	SMD LED diode 0805 format	
DL3	LED	SMD LED diode 0805 format	
DL4	LED	SMD LED diode 0805 format	
OPT1	PC3Q66Q	4 channel opto isolator	
OPT2	PC3Q66Q	4 channel opto isolator	
IC1	VNI4140K	ST IC industrial 4 ch hsd	
J1	Hader 34 pin	Compatible evalcommboard	
J2	Jumper	Over voltage test	
J3	Jumper	Ground disconnection test	
J4	Jumper	Vcc disconnection test	
J5	HADER 14 pin	Compatible ST7CANIC DB	
M1	4 screw plug	HSD output connector	
M2	2 screw plug	Power supply conector	
T1	Test point	HSD output channel 1 voltage	
T2	Test point	HSD output channel 2 voltage	
Т3	Test point	HSD output channel 3 voltage	
T4	Test point	HSD output channel 4 voltage	



	Evaluation board bin of material (continued)		
T5	Test point	HSD input channel 1 signal	
Т6	Test point	HSD input channel 2 signal	
T7	Test point	HSD input channel 3 signal	
Т8	Test point	HSD input channel 4 signal	
Т9	Test point	HSD channel 1 status	
T10	Test point	HSD channel 2 status	
T11	Test point	HSD channel 3 status	
T12	Test point	HSD channel 4 status	

 Table 2.
 Evaluation board bill of material (continued)



4 Revision history

Table 3.Document revision history

Date	Revision	Changes
13-Dec-2007	1	Initial release



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